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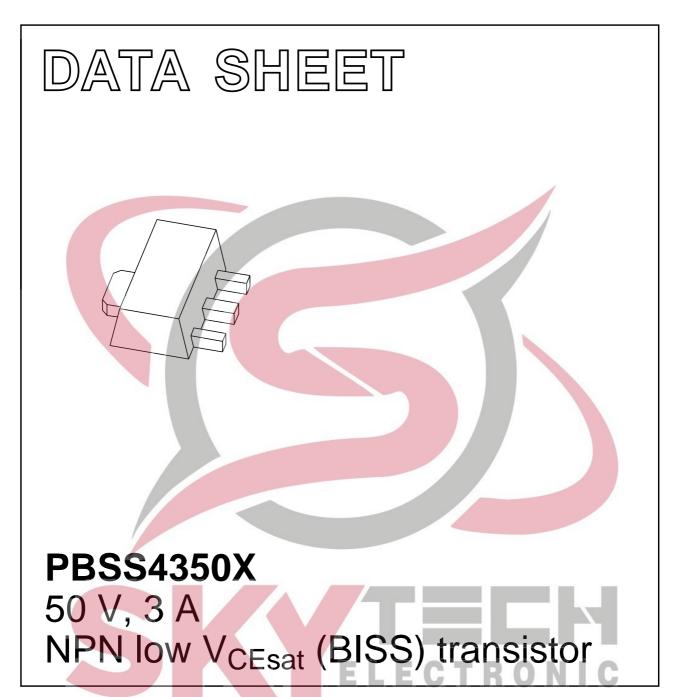
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via salesaddresses@nexperia.com). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

ELECTRONIC

DISCRETE SEMICONDUCTORS



Product specification
Supersedes data of 2003 Nov 21

2004 Nov 04





50 V, 3 A NPN low V_{CEsat} (BISS) transistor

PBSS4350X

FEATURES

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs).
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT89 plastic package. PNP complement: PBSS5350X.

MARKING

TYPE NUMBER	MARKING CODE	
PBSS4350X	S43	

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	50	V
Ic	collector current (DC)	3	Α
I _{CM}	peak collector current 5		Α
R _{CEsat}	equivalent on-resistance 130 ms		mΩ

PINNING

PIN	DESCRIPTION
1	emitter
2	collector
3	base

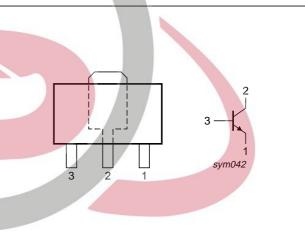


Fig.1 Simplified outline (SOT89) and symbol.



50 V, 3 A NPN low V_{CEsat} (BISS) transistor

PBSS4350X

ORDERING INFORMATION

TYPE NUMBER	PACKAGE			
TIPE NOWIBER	NAME DESCRIPTION VER			
PBSS4350X	SC-62 plastic surface mounted package; collector pad for good heat transfer; 3 leads		SOT89	

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	- /	50	V
V _{EBO}	emitter-base voltage	open collector	- (5	V
I _C	collector current (DC)	note 4	-	3	Α
I _{CM}	peak collector current	limited by T _{j(max)}	-	5	Α
I _B	base current (DC)		-	0.5	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
		note 1	_	550	mW
		note 2	-	1	W
		note 3	-/	1.4	W
		note 4	7	1.6	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

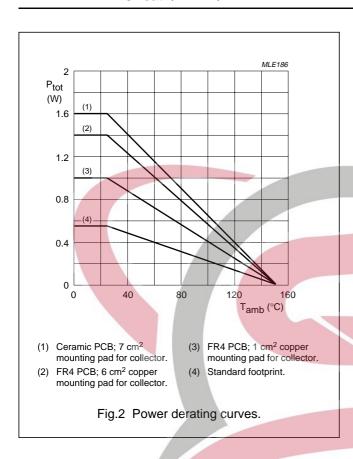
Notes

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².
- 3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm².
- 4. Device mounted on a ceramic printed-circuit board 7 cm², single-sided copper, tin-plated.

ELECTRONIC

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S TECH ELECTRONIC

50 V, 3 A NPN low V_{CEsat} (BISS) transistor

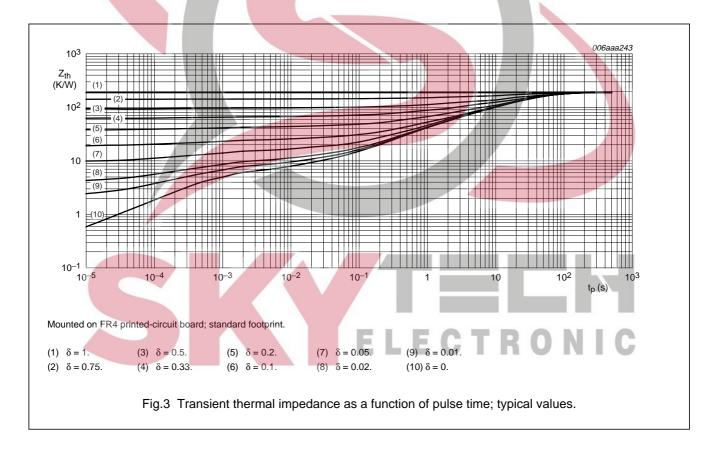
PBSS4350X

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
		note 1	225	K/W
		note 2	125	K/W
		note 3	90	K/W
		note 4	80	K/W
R _{th(j-s)}	thermal resistance from junction to soldering point		16	K/W

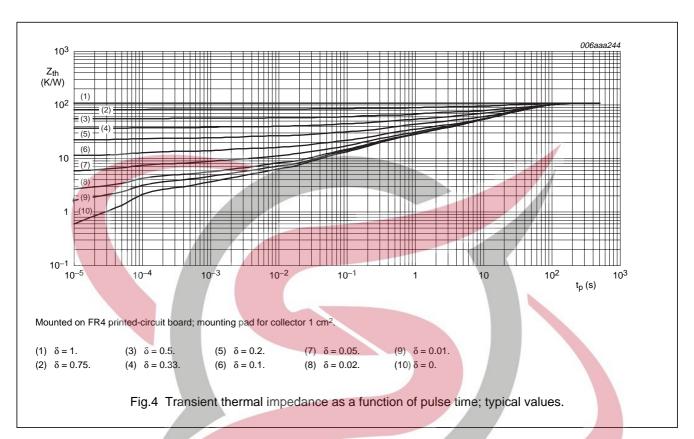
Notes

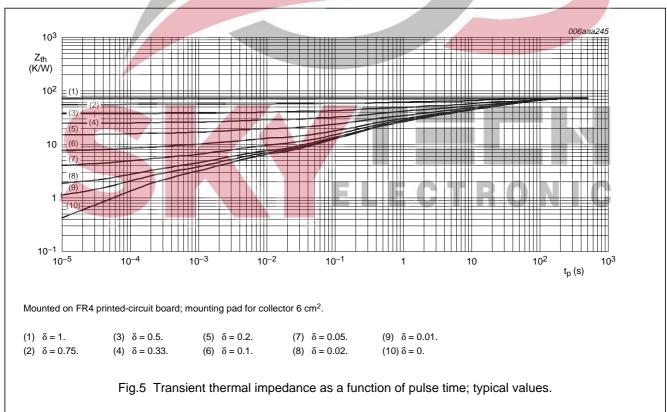
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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0 A	_	_	100	nA
		V _{CB} = 50 V; I _E = 0 A; T _j = 150 °C	_	_	50	μΑ
I _{CES}	collector-emitter cut-off current	V _{CE} = 50 V; V _{BE} = 0 V	_	_	100	nA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A	_	-/	100	nA
h _{FE}	DC current gain	V _{CE} = 2 V		71		
		I _C = 0.1 A	300	-	_	
		I _C = 0.5 A	300	-	_	
		I _C = 1 A; note 1	300	-	700	
		I _C = 2 A; note 1	200	-	_	
		I _C = 3 A; note 1	100	-	_	
V _{CEsat}	collector-emitter saturation	I _C = 0.5 A; I _B = 50 mA	-	_	80	mV
	voltage	$I_C = 1 \text{ A}; I_B = 50 \text{ mA}$	_	-	160	mV
		$I_C = 2 \text{ A}; I_B = 100 \text{ mA}$	_	-	280	mV
		$I_C = 2 \text{ A}$; $I_B = 200 \text{ mA}$; note 1	_	-	260	mV
		I _C = 3 A; I _B = 300 mA; note 1	_	-	370	mV
R _{CEsat}	equivalent on-resistance	I _C = 2 A; I _B = 200 mA; note 1	- /	100	130	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_C = 2 \text{ A}; I_B = 100 \text{ mA}$	-	_	1.1	V
		I _C = 3 A; I _B = 300 mA; note 1	7	_	1.2	V
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 2 V; I _C = 1 A	1.1	-	- /	V
f _T	transition frequency	I _C = 100 mA; V _{CE} = 5 V; f = 100 MHz	100	_	/	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	_	_	25	pF

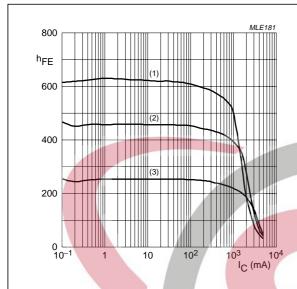
Note

1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$



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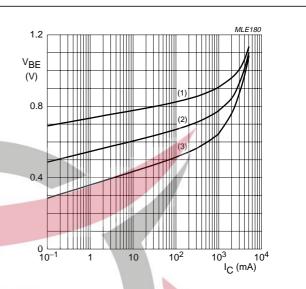
PBSS4350X



 $V_{CE} = 2 V$.

- (1) $T_{amb} = 100 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

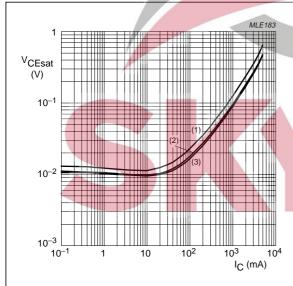
Fig.6 DC current gain as a function of collector current; typical values.



 $V_{CE} = 2 V$

- (1) $T_{amb} = -55 \,^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 100 \, ^{\circ}C$.

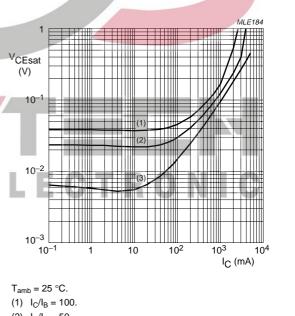
Fig.7 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

- (1) $T_{amb} = 100 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



- (2) $I_C/I_B = 50$.
- (3) $I_C/I_B = 10$.

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.

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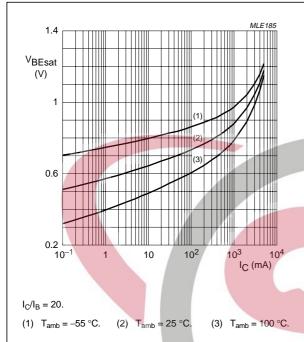


Fig.10 Base-emitter saturation voltage as a function of collector current; typical values.

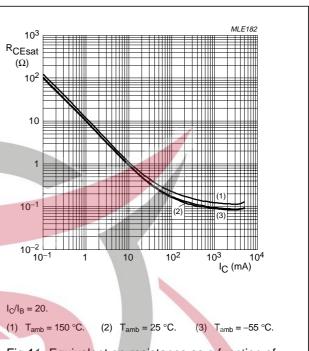
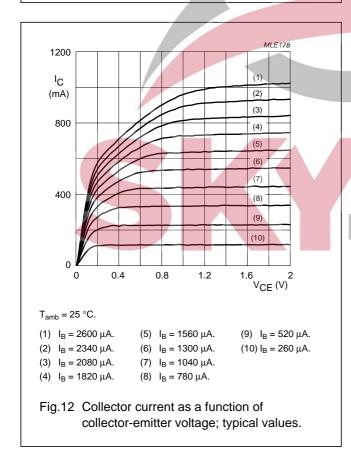
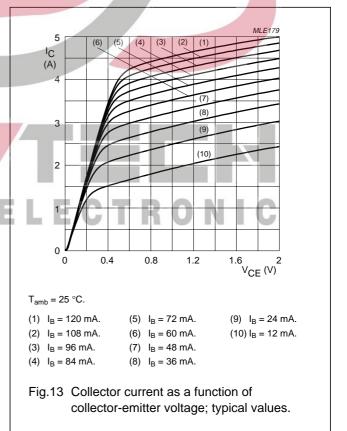


Fig.11 Equivalent on-resistance as a function of collector current; typical values.





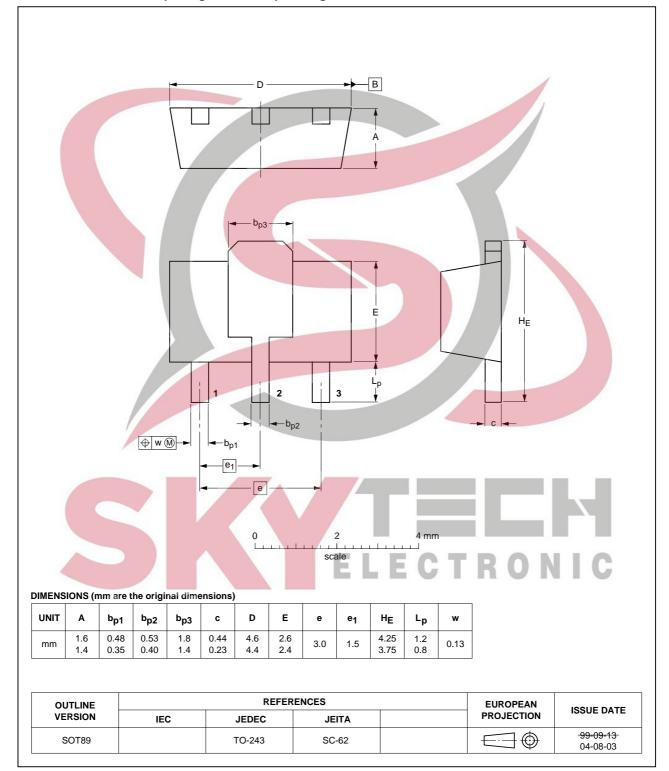
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89



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PBSS4350X

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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